

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	KOK WAI WONG	09/25/2018
RECEIVING PARTY DATA		
Name:	TYCO ELECTRONICS (SHANGHAI) CO. LTD.	
Street Address:	SECTIONS F AND G, LEVEL 1, BUILDING 15	
Internal Address:	NO. 999 YINGLUN ROAD, CHINA (SHANGHAI) PILOT FREE TRADE ZONE	
City:	SHANGHAI	
State/Country:	CHINA	
Name:	INNOGETIC TECHNOLOGY CO., LTD	
Street Address:	3/F, BLDG 2, NO. 10	
Internal Address:	FUTIAN ROAD, XIANGZHOU DISTRICT, GUANGDONG	
City:	ZHUHAI CITY	
State/Country:	CHINA	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	16141030	
CORRESPONDENCE DATA		
Fax Number:	(610)889-3696	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	610-889-3699	
Email:	berwynipdocket@barley.com	
Correspondent Name:	BARLEY SNYDER	
Address Line 1:	2 GREAT VALLEY PARKWAY	
Address Line 2:	SUITE 110	
Address Line 4:	MALVERN, PENNSYLVANIA 19355	
ATTORNEY DOCKET NUMBER:	21334-2699	
NAME OF SUBMITTER:	SALVATORE ANASTASI	
SIGNATURE:	/Salvatore Anastasi/	
DATE SIGNED:	10/12/2018	

Total Attachments: 2

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Attorney Docket No.: 21334-2699

COMBINED DECLARATION AND ASSIGNMENT

As a below-named inventor, I hereby declare that:

this declaration is directed to inventions and improvements disclosed in:

☐ the attached application, or

☒ United States application or PCT international application number 16/141,030 filed on 25 September 2018, entitled Robot Assembling System And Method For Assembling Multi-Layer Cage ("the APPLICATION")

The APPLICATION was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the APPLICATION;

I have reviewed and understand the contents of the APPLICATION, including the claims, and I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37.C.F.R 1.56; AND

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

TYCO ELECTRONICS (SHANGHAI) CO. LTD. AND INNOGETIC TECHNOLOGY CO., LTD ("ASSIGNEE"), corporations organized and existing under and by virtue of the laws of China having their principal place of business at Sections F and G, Level 1, Building 15 No. 999 Yinglun Road China (Shanghai) Pilot Free Trade Zone Shanghai, CN and 3/F, Bldg 2, No.10, Futian Road Xiangzhou District Zhuhai City, Guangdong, CN,

for a valuable consideration, the receipt of which is hereby acknowledged, **I do hereby sell, assign, transfer and set over unto the said ASSIGNEE, its successors and assigns**, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof, and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment

Legal Name	Signature	Date
DAI, Zhiyong		
HU, Lvhai		
DENG, Yingcong		
LIU, Yun		

11-September-2018

Our Ref.: P186028.US.01

Client Ref.: TY-00523 US

WONG, Kok Wai		25/09/2018
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